

**Amendments to the Specification**

**Please rewrite the paragraph on page 9, lines 20-26 of the original specification as follows:**

Of the dielectric layers that make up the dielectric substrate 14 of the passive component 10A according to the first embodiment, the lowermost dielectric layer S7 has an input electrode layer 48 serving as an input terminal, an output electrode layer 50 serving as an output terminal, and four shield electrode layers 52a through, 52b, 52c and 52d serving as shield terminals, which are in the form of via holes.

**Please rewrite the paragraph on page 24, lines 15-20 of the original specification as follows:**

As shown in FIG. 7, the passive component 10E according to the fifth embodiment is of essentially the same structure as the passive component 10A according to the first embodiment, but differs therefrom in that the dielectric substrate 14 has a filter of lumped-constant circuit 210 therein. Repeat descriptions of like elements are omitted.

**Please rewrite the substitute specification paragraph submitted on May 30, 2007 corresponding to page 25, lines 9-14 of the original specification as follows:**

The second through fifth dielectric layers S2 through, S3, S4 and S5 have, on principal surfaces thereof, first through fifth inductive electrodes 228a, 228b, 228c, 228d, 228e for providing inductance. The first through fifth inductive electrodes 228a through, 228b, 228c, 228d and 228e are connected and formed into a coil by via holes 230, 232, 234, 236.

**Please rewrite the substitute specification paragraph submitted on May 30, 2007 corresponding to page 25, lines 15-18 of the original specification as follows:**

The seventh through ninth dielectric layers S7-through, S8 and S9 have, on principal surfaces thereof, first through fourth capacitive electrodes 238a, 238b, 238c, 238d for providing capacitance.